Note: TIDA-01054 board was used to build this reference design TIDA-01057
PCB Number: TIDA-010577
PCB Rev: E1

PCB
LOGO
Texas Instruments
Pb-Free Symbol

Label Table

<table>
<thead>
<tr>
<th>Varn</th>
<th>Label Text</th>
</tr>
</thead>
<tbody>
<tr>
<td>01</td>
<td>ChangeMe!</td>
</tr>
<tr>
<td>02</td>
<td>ChangeMe!</td>
</tr>
</tbody>
</table>

Assembly Note

ZZ2
These assemblies are ESD sensitive. ESD precautions shall be observed.

ZZ3
These assemblies must be clean and free from flux and all contaminants. Use of no-clean flux is not acceptable.

ZZ4
These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.
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